

DATE 17 MAR 2017

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. SLOT REQUIRED, NOTCH MAY BE ROUNDED.

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 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH.

 MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE

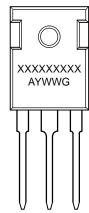
 DIMENSIONS ARE MEASURED AT THE OUTERMOST

 EXTREME OF THE PLASTIC BODY.
- 5. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.
- ©P SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.

 DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.70	5.30	
A1	2.20	2.60	
b	1.07	1.33	
b2	1.65	2.35	
b4	2.60	3.40	
С	0.45	0.68	
D	20.80	21.34	
E	15.50	16.25	
E2	4.32	5.49	
е	5.45	BSC	
F	2.655		
L	19.80	20.80	
L1	3.81	4.32	
P	3.55	3.65	
Q	5.40	6.20	
S	6.15 BSC		

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location

Υ = Year WW = Work Week G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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ISSUE	REVISION	DATE
0	RELEASED TO PRODUCTION. REQ. BY D. TRUHITTE.	26 JUN 2013
Α	REMOVED DIMENSION A2. REQ. BY S. BRUTCHER.	01 AUG 2013
В	MODIFED DIMENSIONS D AND L1. REQ. BY C. ENRIQUEZ.	08 MAR 2016
С	ADDED DIMENSION F. REQ. BY C. ENRIQUEZ.	30 NOV 2016
D	MODIFED DIMENSIONS b AND c. REQ. BY C. ENRIQUEZ.	17 MAR 2017

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